

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

FLEXIBLE CIRCUIT BOARD, METHOD FOR MAKING THE SAME, FLEXIBLE MULTI-LAYER
WIRING CIRCUIT BOARD, AND METHOD FOR MAKING THE SAME

the specification of which is attached hereto unless the following is checked

was filed on 10/05/2004 as United States Application Number or PCT International

Application Number PCT/JP2004/006248 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

(List prior foreign applications. See note A)	Priority Claimed		
2003-133005 (Number)	Japan (Country)	12/05/2003 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
(See note B)	<input type="checkbox"/> See attached list for additional prior foreign applications		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List prior U.S. Applications)	Status	
(Application Serial No.)	(Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
(Application Serial No.)	(Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned
(Application Serial No.)	(Filing Date)	<input type="checkbox"/> Patented <input type="checkbox"/> Pending <input type="checkbox"/> Abandoned

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

23850

PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C) Full name of sole or first inventor (given name, family name) Tomoo Iijima Date 15/11/2005
Inventor's signature Tomoo Iijima Citizenship Japan
Residence Tokyo, Japan
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170-0005 Japan

Full name of second inventor (given name, family name) Kenji OSAWA Date 15/11/2005
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Full name of third inventor (given name, family name) Kimitaka ENDO Date 15/11/2005
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Full name of fourth inventor (given name, family name) Yoshiaki ECHIGO Date 21/11/2005
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Full name of fifth inventor (given name, family name) Akira SHIGETA Date 21/11/2005
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Full name of sixth inventor (given name, family name) Kazuyoshi KOBAYASHI
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Date 8/11/2005
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Full name of seventh inventor (given name, family name) Kenichiro HANAMURA
Inventor's signature Kenichiro Hanamura
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322-8502 Japan

Date 9/11/2005
Citizenship Japan

Full name of eighth inventor (given name, family name)
Inventor's signature _____
Residence _____
Post Office Address _____

Date _____
Citizenship _____
